

# FM20L40-T7B THRU FM20L100-T7B

## List

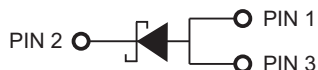
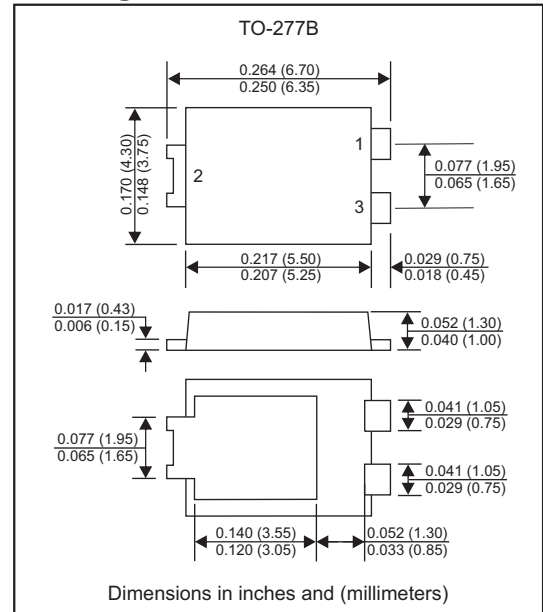
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**FM20L40-T7B THRU FM20L100-T7B****20.0A Surface Mount Trench MOS  
Schottky Barrier Rectifiers 40V-100V****Features**

- High current density schottky
- Low forward voltage drop
- Excellent high temperature stability
- High forward surge current capability
- Lead free finish,RoHS compliant
- Suffix "-H" indicates Halogen free parts, ex. FM20L40-T7B-H

**Mechanical data**

- Epoxy:UL94-V0 rated flame retardant
- Case : Molded plastic, TO-277B
- Terminals: Plated terminals, solderable per MIL-STD-750, Method 2026
- Polarity : Indicated by cathode band
- Mounting Position : Any
- Weight:0.092 grams(approx)

**Package outline****Maximum ratings** (AT  $T_A=25^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                                                            | SYMBOLS   | FM20L40-T7B | FM20L45-T7B | FM20L50-T7B | FM20L60-T7B | FM20L80-T7B | FM20L100-T7B | UNIT               |
|----------------------------------------------------------------------|-----------|-------------|-------------|-------------|-------------|-------------|--------------|--------------------|
| Maximum repetitive peak reverse voltage                              | $V_{RRM}$ | 40          | 45          | 50          | 60          | 80          | 100          | V                  |
| Maximum RMS voltage                                                  | $V_{RMS}$ | 28          | 31.5        | 35          | 42          | 56          | 70           | V                  |
| Maximum continuous reverse voltage                                   | $V_R$     | 40          | 45          | 50          | 60          | 80          | 100          | V                  |
| Maximum average forward rectified current                            | $I_O$     | 20          |             |             |             |             |              | A                  |
| Peak forward surge current 8.3ms single half sine-wave(JEDEC method) | $I_{FSM}$ | 250         |             |             |             |             |              | A                  |
| Operating junction temperature range                                 | $T_J$     | -55 to +150 |             |             |             |             |              | $^{\circ}\text{C}$ |
| Storage temperature range                                            | $T_{STG}$ | -55 to +150 |             |             |             |             |              | $^{\circ}\text{C}$ |

**Electrical characteristics** (AT  $T_A=25^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                                                             | SYMBOLS | FM20L40-T7B  | FM20L45-T7B | FM20L50-T7B | FM20L60-T7B  | FM20L80-T7B  | FM20L100-T7B | UNIT |
|-----------------------------------------------------------------------|---------|--------------|-------------|-------------|--------------|--------------|--------------|------|
| Maximum forward voltage at $I_F=2.0\text{A}$<br>at $I_F=20.0\text{A}$ | $V_F$   | 0.35<br>0.48 |             |             | 0.40<br>0.55 | 0.45<br>0.70 |              | V    |
| Maximum reverse current<br>at rated $V_R$                             | $I_R$   | 0.5<br>50    |             |             |              | 0.2<br>20    |              | mA   |

**Thermal characteristics**

| PARAMETER                                         | SYMBOLS         | FM20L40-T7B | FM20L45-T7B | FM20L50-T7B | FM20L60-T7B | FM20L80-T7B | FM20L100-T7B | UNIT                 |
|---------------------------------------------------|-----------------|-------------|-------------|-------------|-------------|-------------|--------------|----------------------|
| Typical thermal resistance<br>junction to ambient | $R_{\theta JA}$ | 60.0        |             |             |             |             |              | $^{\circ}\text{C/W}$ |

Note 1: Mounted on FR-4 PCB copper pad area. Cathode pad dimensions 4.95mm x 3.4mm. Anode pad dimensions 1.55mm x 5.0mm.

## Rating and characteristic curves(FM20L40-T7B THRU FM20L100-T7B)

Fig.1 TYPICAL FORWARD CHARACTERISTICS

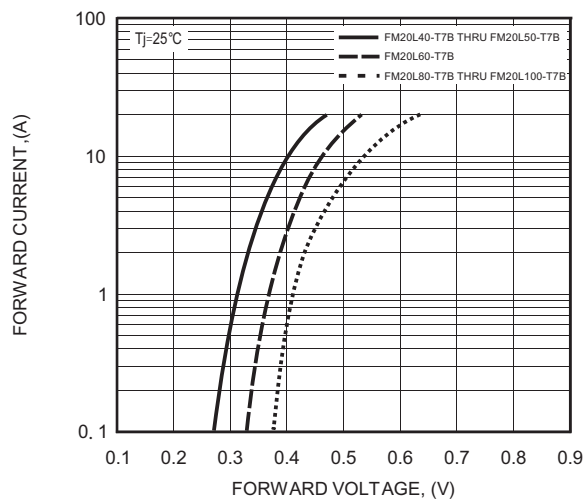


Fig.2 MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

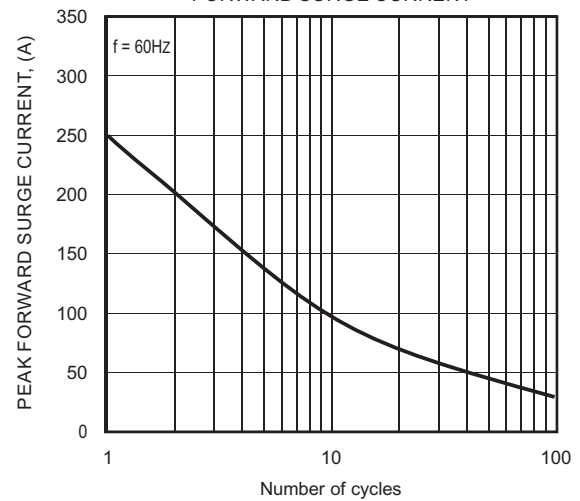


Fig.3 TYPICAL REVERSE LEAKAGE CHARACTERISTICS

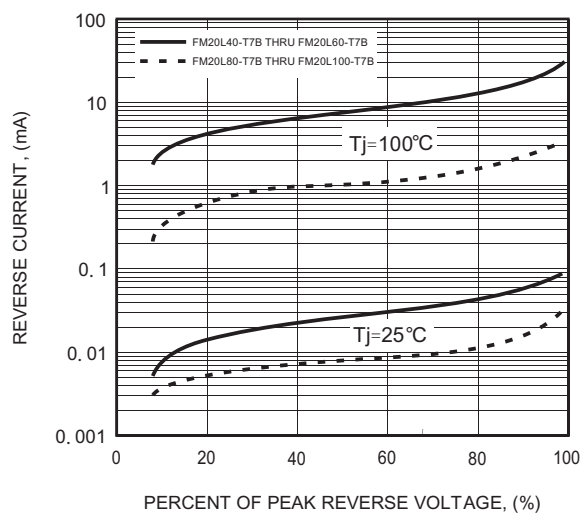
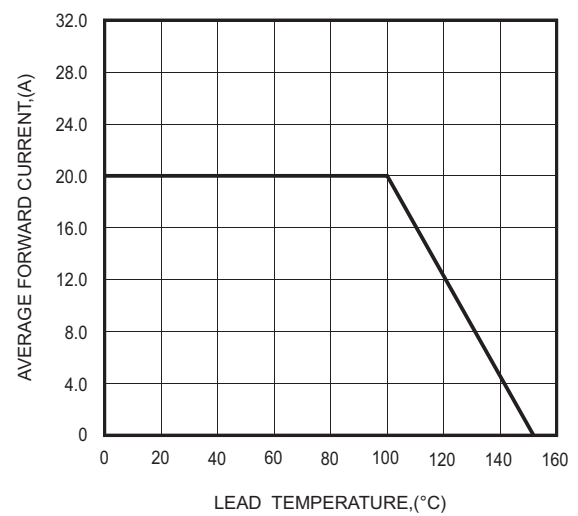
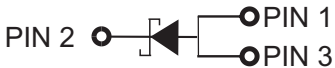


Fig.4 TYPICAL FORWARD CURRENT DERATING CURVE

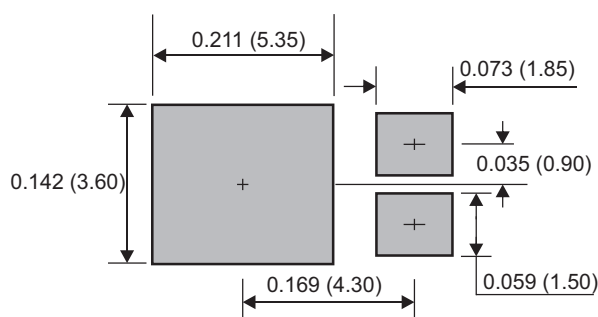


**FM20L40-T7B THRU FM20L100-T7B****Pinning information**

| Pin                                         | Simplified outline                                                                | Symbol                                                                              |
|---------------------------------------------|-----------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|
| PIN 1 anode<br>PIN 3 anode<br>PIN 2 cathode |  |  |

**Marking**

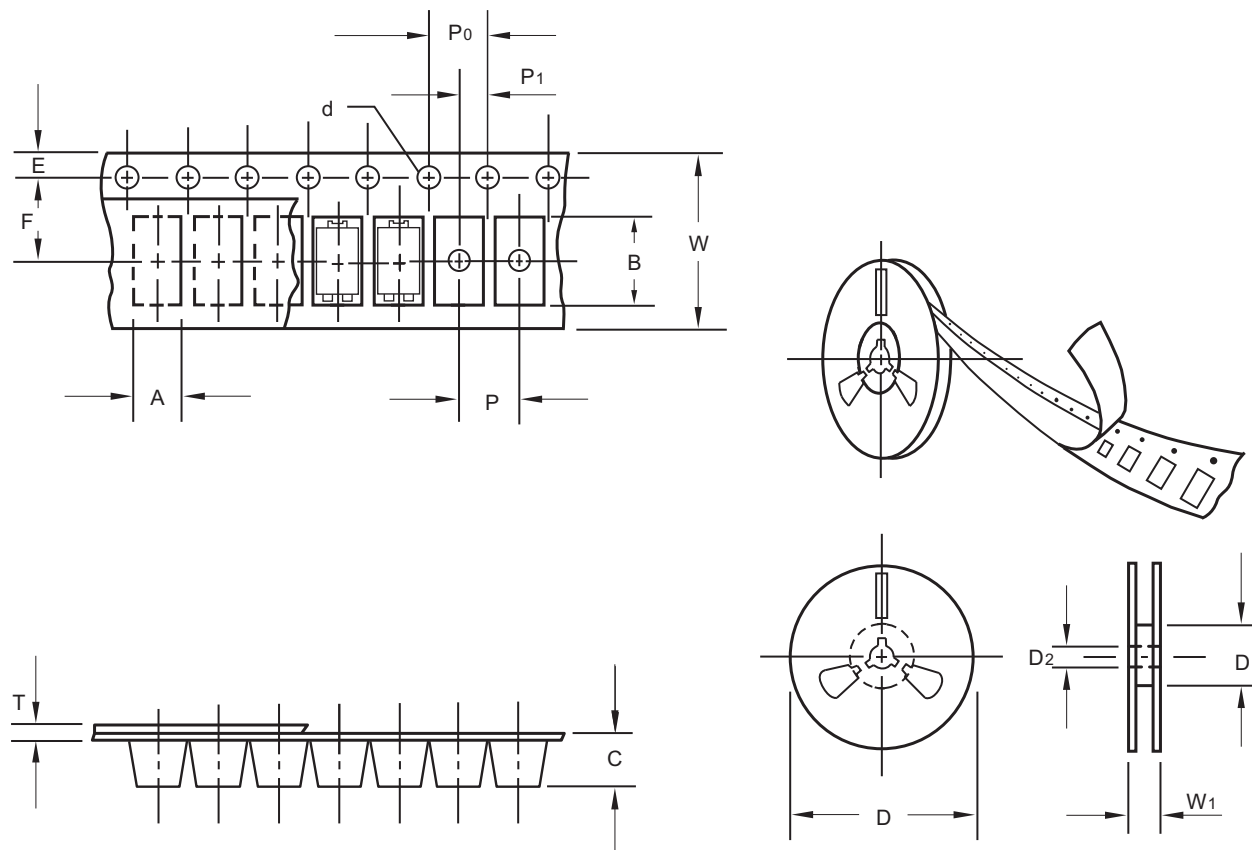
| Type number  | Marking code |
|--------------|--------------|
| FM20L40-T7B  | SL2040       |
| FM20L45-T7B  | SL2045       |
| FM20L50-T7B  | SL2050       |
| FM20L60-T7B  | SL2060       |
| FM20L80-T7B  | SL2080       |
| FM20L100-T7B | SL20100      |

**Suggested solder pad layout****TO-277B**

Dimensions in inches and (millimeters)

## FM20L40-T7B THRU FM20L100-T7B

## Packing information



unit:mm

| Item                      | Symbol         | Tolerance | TO-277B |
|---------------------------|----------------|-----------|---------|
| Carrier width             | A              | 0.1       | 4.40    |
| Carrier length            | B              | 0.1       | 6.90    |
| Carrier depth             | C              | 0.1       | 1.30    |
| Sprocket hole             | d              | 0.1       | 1.55    |
| 13" Reel outside diameter | D              | 2.0       | 330.00  |
| 13" Reel inner diameter   | D <sub>1</sub> | min       | 50.00   |
| 7" Reel outside diameter  | D              | 2.0       | 178.00  |
| 7" Reel inner diameter    | D <sub>1</sub> | min       | 62.00   |
| Feed hole diameter        | D <sub>2</sub> | 0.5       | 13.00   |
| Sprocket hole position    | E              | 0.1       | 1.75    |
| Punch hole position       | F              | 0.1       | 7.50    |
| Punch hole pitch          | P              | 0.1       | 8.00    |
| Sprocket hole pitch       | P <sub>0</sub> | 0.1       | 4.00    |
| Embossment center         | P <sub>1</sub> | 0.1       | 2.00    |
| Overall tape thickness    | T              | 0.1       | 0.25    |
| Tape width                | W              | 0.3       | 12.00   |
| Reel width                | W <sub>1</sub> | 1.0       | 14.00   |

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

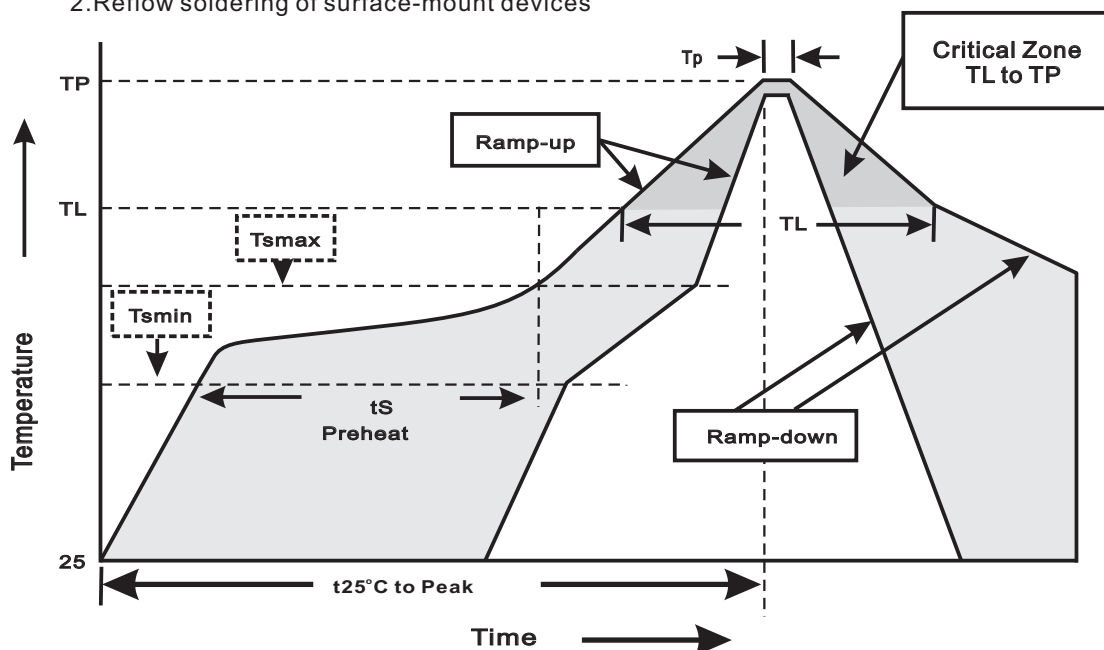
## FM20L40-T7B THRU FM20L100-T7B

## Reel packing

| PACKAGE | REEL SIZE | REEL (pcs) | COMPONENT SPACING (m/m) | BOX (pcs) | INNER BOX (m/m) | REEL DIA, (m/m) | CARTON SIZE (m/m) | CARTON (pcs) | APPROX. GROSS WEIGHT (kg) |
|---------|-----------|------------|-------------------------|-----------|-----------------|-----------------|-------------------|--------------|---------------------------|
| TO-277B | 13"       | 5,000      | 8.0                     | 10,000    | 335*335*38      | 330             | 350*330*360       | 80,000       | 18.0                      |

## Suggested thermal profiles for soldering processes

- 1.Storage environment: Temperature=5°C~40°C Humidity=55%±25%
- 2.Reflow soldering of surface-mount devices



## 3.Reflow soldering

| Profile Feature                                                                                                               | Soldering Condition         |
|-------------------------------------------------------------------------------------------------------------------------------|-----------------------------|
| Average ramp-up rate(T <sub>L</sub> to T <sub>P</sub> )                                                                       | <3°C/sec                    |
| Preheat<br>-Temperature Min(T <sub>smin</sub> )<br>-Temperature Max(T <sub>smax</sub> )<br>-Time(min to max)(t <sub>s</sub> ) | 150°C<br>200°C<br>60~120sec |
| T <sub>smax</sub> to T <sub>L</sub><br>-Ramp-upRate                                                                           | <3°C/sec                    |
| Time maintained above:<br>-Temperature(T <sub>L</sub> )<br>-Time(t <sub>L</sub> )                                             | 217°C<br>60~260sec          |
| Peak Temperature(T <sub>P</sub> )                                                                                             | 255°C-0/+5°C                |
| Time within 5°C of actual Peak Temperature(t <sub>P</sub> )                                                                   | 10~30sec                    |
| Ramp-down Rate                                                                                                                | <3°C/sec                    |
| Time 25°C to Peak Temperature                                                                                                 | <6minutes                   |

**FM20L40-T7B THRU FM20L100-T7B****High reliability test capabilities**

| Item Test                         | Conditions                                                                                                                               | Reference                     |
|-----------------------------------|------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------|
| 1. Solder Resistance              | at $260 \pm 5^\circ\text{C}$ for $10 \pm 2$ sec.                                                                                         | MIL-STD-750D<br>METHOD-2031   |
| 2. Solderability                  | at $245 \pm 5^\circ\text{C}$ for 5 sec.                                                                                                  | MIL-STD-202F<br>METHOD-208    |
| 3. High Temperature Reverse Bias  | $V_R = 80\%$ rate at $T_J = 150^\circ\text{C}$ for 168 hrs.                                                                              | MIL-STD-750D<br>METHOD-1038   |
| 4. Forward Operation Life         | Rated average rectifier current at $T_A = 25^\circ\text{C}$ for 500hrs.                                                                  | MIL-STD-750D<br>METHOD-1027   |
| 5. Intermittent Operation Life    | $T_A = 25^\circ\text{C}$ , $I_F = I_O$<br>On state: power on for 5 min.<br>off state: power off for 5 min.<br>on and off for 500 cycles. | MIL-STD-750D<br>METHOD-1036   |
| 6. Pressure Cooker                | $15P_{SIG}$ at $T_A = 121^\circ\text{C}$ for 4 hrs.                                                                                      | JESD22-A102                   |
| 7. Temperature Cycling            | $-55^\circ\text{C}$ to $+125^\circ\text{C}$ dwelled for 30 min.<br>and transferred for 5min. total 10 cycles.                            | MIL-STD-750D<br>METHOD-1051   |
| 8. Forward Surge                  | 8.3ms single half sine-wave , one surge.                                                                                                 | MIL-STD-750D<br>METHOD-4066-2 |
| 9. Humidity                       | at $T_A = 85^\circ\text{C}$ , RH=85% for 1000hrs.                                                                                        | MIL-STD-750D<br>METHOD-1021   |
| 10. High Temperature Storage Life | at $150^\circ\text{C}$ for 1000 hrs.                                                                                                     | MIL-STD-750D<br>METHOD-1031   |